

# ATMXT2952TD-C2UEN 2.0

# maXTouch 2911-node Touchscreen Controller Product Brief

#### Description

The ATMXT2952TD-C2UEN 2.0 uses a unique charge-transfer acquisition engine to implement Microchip's patented capacitive sensing method. Coupled with a state-of-the-art CPU, the entire touchscreen sensing solution can measure, classify and track a number of individual finger touches with a high degree of accuracy in the shortest response time. The ATMXT2952TD-C2UEN 2.0 allows for both mutual and self capacitance measurements, with the self capacitance measurements being used to augment the mutual capacitance measurements to produce reliable touch information.

# maXTouch<sup>®</sup> Adaptive Sensing Technology

- Up to 41 X (transmit) lines and 71 Y (receive) lines for use by a touchscreen and/or key array
- A maximum of 2911 nodes can be allocated to the touch sensor
- Touchscreen size 21 inches (16:9 aspect ratio), assuming a sensor electrode pitch of 6.5 mm. Other sizes are possible with different electrode pitches and appropriate sensor material
- Multiple touch support with up to 16 concurrent touches tracked in real time
- HID Mouse mode reporting of single touches to the host, subject to configuration

#### **Touch Sensor Technology**

- On-cell/touch-on display support including OLED and LCD
- Discrete/out-cell support including glass and PET filmbased sensors
- · Synchronization with display refresh timing capability
- Support for standard (for example, Diamond) and proprietary sensor patterns (review of designs by Microchip or a Microchip-qualified touch sensor module partner is recommended)

#### **Front Panel Material and Design**

- Works with PET or glass, including curved profiles (configuration and stack-up to be approved by Microchip or a Microchip-qualified touch sensor module partner)
- 10 mm glass (or 5 mm PMMA) with bare finger (dependent on sensor size, touch size, configuration and stack-up)
- 6 mm glass (or 3 mm PMMA) with multi-finger 5 mm glove (2.7 mm PMMA equivalent) (dependent on sensor size, touch size, configuration and stack-up)
- Support for non-rectangular sensor designs (for example, circular, rounded or with cutouts)

#### **Touch Performance**

- Moisture/Water Compensation
  - No false touch with condensation or water drop up to 22 mm diameter
  - One-finger tracking with condensation or water drop up to 22 mm diameter
- Multiple acquisition schemes for robust and sensitive multi-touch sensing, including:
  - Mutual capacitance capacitance measurements
  - Self Capacitance measurements
  - P2P Mutual Capacitance measurements
- Noise suppression technology to combat ambient and power-line noise
  - Up to 240 V<sub>PP</sub> between 1 Hz and 1 kHz sinusoidal waveform (no touches)
  - Up to 20 V<sub>PP</sub> between 1 kHz and 1 MHz sinusoidal waveform
- Stylus Support
  - Supports passive stylus with 1.5 mm contact diameter, subject to configuration, stack-up, and sensor design
- Burst Frequency
  - Flexible and dynamic Tx burst frequency selection to reduce EMC disturbance
  - Configurable Tx waveform shaping to reduce emissions
- Scan Speed
  - Typical report rate for 10 touches ≥110 Hz (subject to configuration)
  - Initial touch latency <20 ms for first touch from idle (subject to configuration)
  - Configurable for power and speed optimization

- Touch panel failure detection
  - Automatic touch sensor diagnostics during run time to support the implementation of safety critical features
  - Diagnostics reported using dedicated output pin or by standard Object Protocol messages
  - Configurable test limits

#### Keys

- Up to 32 nodes can be allocated as mutual capacitance sensor keys in addition to the touchscreen, defined as 1 key array (subject to availability of X and Y lines and other configurations)
- · Adjacent Key Suppression (AKS) technology is supported for false key touch prevention

#### **PWM Signal Generation**

· PWM Output for display backlight control, audible speaker/buzzer output, or simple haptic feedback

#### **Enhanced Algorithms**

- · Lens bending algorithms to remove display noise
- · Touch suppression algorithms to remove unintentional large touches
- · Palm Recovery Algorithm for quick restoration to normal state
- · Enhanced Touch Separation algorithm for improved two touch separation/tracking in all directions.

#### **On-chip Gestures**

· Reports one-touch and two-touch gestures

#### **Data Store**

- 60-byte CRC checksummed data area for use as a run-time Product Data Store Area
- 64-byte data area for user's custom data (not CRC checksummed)

#### **Device Security**

- Encrypted configuration parameters and touch coordinate reports (OBP messages) using customer's own security key
- · Firmware Authentication mechanism to ensure the authenticity of the application firmware in the device

#### **Power Saving**

- · Programmable timeout for automatic transition from Active to Idle state
- · Pipelined analog sensing detection and digital processing to optimize system power efficiency

#### **Application Interfaces**

- Client interface for main communication with the device. Can be one of:
  - I<sup>2</sup>C interface, with support for Standard mode (up to 100 kHz), Fast mode (up to 400 kHz), Fast-mode Plus (up to 1 MHz), High Speed mode (up to 3.4 MHz)
  - HID-I<sup>2</sup>C interface for Microsoft Windows 10
  - USB HID interface for Microsoft Windows 10
- · Interrupt to indicate when a message is available
- · Additional SPI Debug Interface to read the raw data for tuning and debugging purposes

#### **Power Supply**

- Digital (Vdd) 3.3V nominal
- Digital I/O (VddIO) 1.8V to 3.3V (I<sup>2</sup>C mode), 3.3V nominal (USB mode)
- Analog (AVdd) 3.3V nominal
- High voltage external X line drive (XVdd) up to 9.2V

### Package

• 162-ball UFBGA 10 × 5 × 0.6 mm, 0.5 mm pitch

#### **Operating Temperature**

• −40°C to +85°C

### **Design Services**

• Specific design and tuning tools available as maXTouch Studio plug-ins

# ATMXT2952TD-C2UEN 2.0

## **PIN CONFIGURATION**

#### 162-ball UFBGA

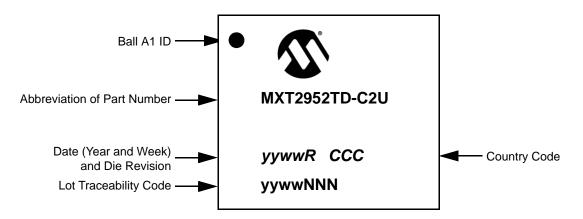
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DS40002574A-page 4

### 1.0 PACKAGING INFORMATION

#### 1.1 Package Marking Information

1.1.1 162-BALL UFBGA



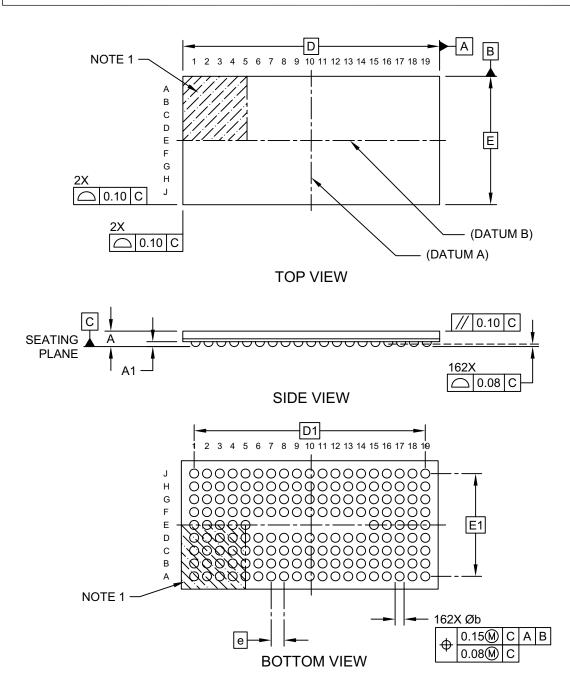
#### 1.1.2 ORDERABLE PART NUMBERS

The product identification system for maXTouch devices is described in "Product Identification System" on page 10. That section also lists example part numbers for the device.

#### 1.2 Package Details

#### 162-Ball Ultra Thin Fine Pitch Ball Grid Array (C6B) - 10x5x0.6 mm Body [UFBGA] Atmel Legacy Global Package Code CAK

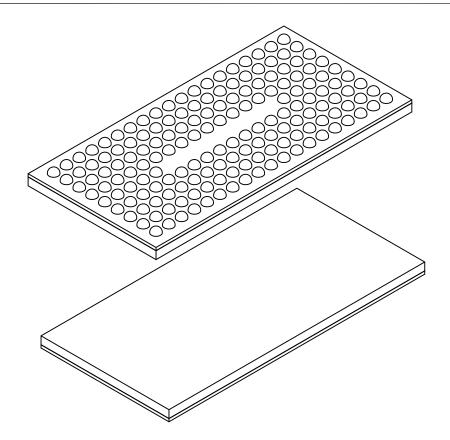
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-21167 Rev A Sheet 1 of 2

#### 162-Ball Ultra Thin Fine Pitch Ball Grid Array (C6B) - 10x5x0.6 mm Body [UFBGA] Atmel Legacy Global Package Code CAK

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



		Units	Ν	<b>IILLIMETER</b>	S
	Dimension	Limits	MIN	NOM	MAX
Number of Terminals		N		162	
Pitch		е		0.50 BSC	
Overall Height		Α	0.488	0.546	0.60
Standoff		A1	0.120	0.155	0.190
Overall Length		D		10.00 BSC	
Overall Ball Spacing		D1		9.00 BSC	
Overall Width		E		5.00 BSC	
Exposed Pad Width		E1	4.00 BSC		
Ball Diameter		b	0.20	0.25	0.30

Notes:

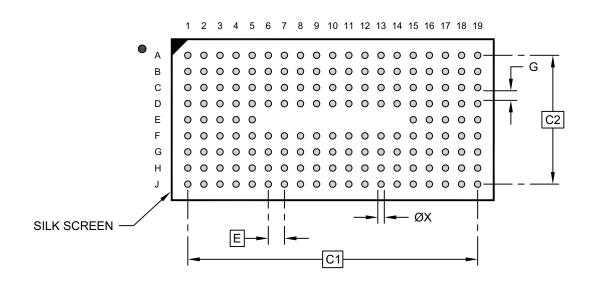
- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Dimensioning and tolerancing per ASME Y14.5M
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-21167 Rev A Sheet 2 of 2

#### 162-Ball Ultra Thin Fine Pitch Ball Grid Array (C6B) - 10x5x0.6 mm Body [UFBGA] Atmel Legacy Global Package Code CAK

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



#### **RECOMMENDED LAND PATTERN**

	Units	MILLIMETERS				
Dimension	Limits	MIN	NOM	MAX		
Contact Pitch	ш		0.50 BSC			
Contact Pad Spacing	C1		9.00 BSC			
Contact Pad Spacing	C2		4.00 BSC			
Contact Pad Diameter (X162)	X1			0.20		
Contact Pad to Contact Pad	G	0.30				

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-23167 Rev A

# APPENDIX A: REVISION HISTORY

### **Revision A (April 2024)**

Initial edition for firmware revision 2.0.AA - Release

## **PRODUCT IDENTIFICATION SYSTEM**

The table below gives details on the product identification system for maXTouch devices. See "Orderable Part Numbers" below for example part numbers for the ATMXT2952TD-C2UEN.

To order or obtain information, for example on pricing or delivery, refer to the factory or the listed sales office.

 Device	 Package	e Te	 emperature Range	ا Tape and Reel Option	 Pattern
Device:	Base dev	ice nam	ne		
Package:	C2	=	UFBGA (U	Itra Thin Fine-pit	ch Ball Grid Array)
	NH	=	UFBGA (U	Itra Thin Fine-pit	ch Ball Grid Array)
	C4	=	X1FBGA (	Extra Thin Fine-p	oitch Ball Grid Array)
	MA	=	XQFN (Su	per Thin Quad F	lat No Lead Sawn)
	MA5	=	XQFN (Su	per Thin Quad F	lat No Lead Sawn)
Temperature Range:	U	=	–40°C to +	85°C (Grade 3)	
Tape and Reel Option: (1)	Blank	=	Standard I	Packaging (Tube	or Tray)
	R	=	Tape and I	Reel	
Pattern:	Extensior (Blank Ot			or Special Requ	irements
Note 1: Tape and Reel identii	,		,		otion. This identifier is used for

# Orderable Part Numbers

Orderable Part Number	Firmware Revision	Family ID	Variant ID	Description
ATMXT2952TD-C2UEN1 (Supplied in trays)	2.0.AA	0xA4	0.450	162-ball UFBGA 10 × 5 × 0.6 mm, RoHS compliant
ATMXT2952TD-C2UREN1 (Supplied in tape and reel)	2.0.AA	UXA4	0x59	Industrial grade; not suitable for automotive characterization

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